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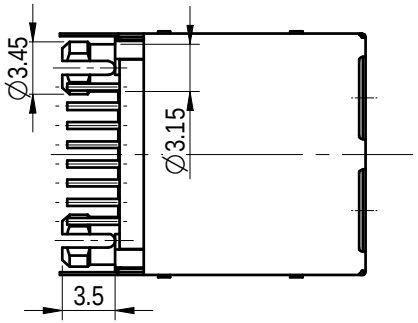
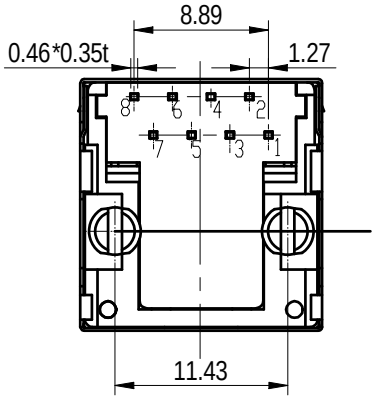
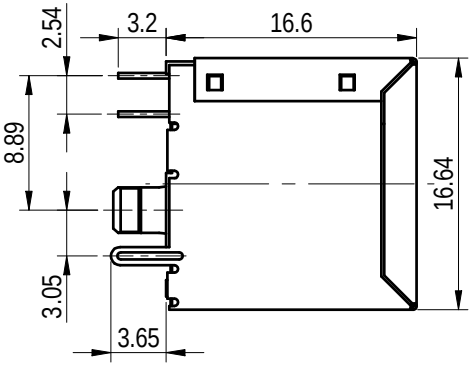
Notes:
1. Electrical Characteristics:
   1.1 Contact Resistance: 30mΩ Max.
   1.2 Dielectric Withstanding Voltage: 500V AC(rms) For 1 Minute.
   1.3 Insulation Resistance: 1000MΩ Min.
   1.4 Current Rating:1.5A.
   1.5 Voltage Rating:125V AC rms.
2. Environment Characteristics:
   2.1 Temperature: -40°C~+85°C.
3. Materials:
   3.1 Contact Material: Copper Alloy.
   3.2 Contact Plating: Seclective gold flash.
   3.3 Insulator Materials: PBT,UL94-V0.
4. Product Number Code:

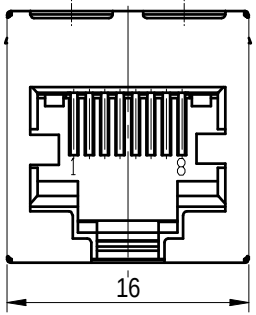
DG1134-07 - X X X X X

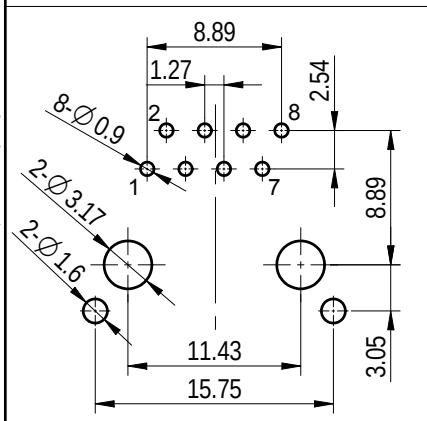
- Housing Material: P:PBT
- Contact Plating: 0:Seclective gold flash; 5:Selective 15u" gold; 3:Selective 30u" gold
- Housing Color: B:Black
- No.Of Contacts: 8:8p8c
- Connector Type: S:Socket











PCB layout
Thickness=1.6mm

(Series Image-Reference Only)

GENERAL TOLERANCE	
X.	±0.60
.X	±0.38
.XX	±0.25

DEGSON

APPD:	兰春华	2023.08.10
CHKD:	陈招	2023.08.10
DRFT:	唐本恒	2023.08.10

A4 | mm (inch)

MATERIAL:	SURFACE/COLOR:
MAT NO./REV: / 00	MAT STATUS: 批量

NAME: DG1134-07-XXXXX

DRAWING NO.	TYPE	DRAWING STATUS	SCALE	SHEET
200035069	CUSTOMER DRAWING	已发布	1:1	1/1

REV	ECN	DESCRIPTION	DRFT	DATE
00			唐本恒	2023.08.10